

AOW10N60/AOWF10N60

600V,10A N-Channel MOSFET

General Description

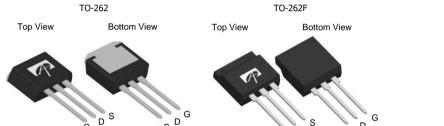
The AOW10N60 & AOWF10N60 have been fabricated using an advanced high voltage MOSFET process that is designed to deliver high levels of performance and robustness in popular AC-DC applications. By providing low $R_{\rm DS(on)},\,C_{\rm iss}$ and $C_{\rm rss}$ along with guaranteed avalanche capability these parts can be adopted quickly into new and existing offline power supply designs.

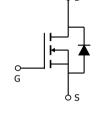
Product Summary

 $\begin{array}{lll} V_{DS} & 700V@150{^\circ\!\!C} \\ I_D \ (at \ V_{GS} \! = \! 10V) & 10A \\ R_{DS(ON)} \ (at \ V_{GS} \! = \! 10V) & < 0.75\Omega \end{array}$

100% UIS Tested 100% R_g Tested







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IANGAIIITA	Marimiim	Ratings	I 75°C IINIASS	OTDATWISE DOTAG

Parameter		Symbol	AOW10N60	AOWF10N60	Units
Drain-Source Voltage		V _{DS}	600		V
Gate-Source Voltage		V_{GS}	±30		V
Continuous Drain	T _C =25°C	I.	10	10*	
Current	T _C =100°C	I _D	7.2	7.2*	Α
Pulsed Drain Current ^C		I _{DM}	36		
Avalanche Current ^C		I _{AR}	4.4		А
Repetitive avalanche energy ^C		E_{AR}	290		mJ
Single plused avalanche energy ^G		E _{AS}	580		mJ
Peak diode recovery dv/dt		dv/dt	5		V/ns
	T _C =25°C	$-P_D$	250	28	W
Power Dissipation ^B	Derate above 25°C	ט י	2	0.22	W/°C
Junction and Storage Temperature Range		T_J , T_{STG}	-55 to 150		°C
Maximum lead temperature for soldering		T ₁	300		°C

purpose, 1/8" from case for 5 seconds Thermal Characteristics

The man emanasteriories					
Parameter	Symbol	AOW10N60	AOWF10N60	Units	
Maximum Junction-to-Ambient A,D	$R_{\theta JA}$	65	65	°C/W	
Maximum Case-to-sink ^A	$R_{\theta CS}$	0.5		°C/W	
Maximum Junction-to-Case	$R_{\theta,JC}$	0.5	4.5	°C/W	

^{*} Drain current limited by maximum junction temperature.



Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units			
STATIC PARAMETERS									
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250µA, V _{GS} =0V, T _J =25°C	600						
		$I_D = 250 \mu A, V_{GS} = 0V, T_J = 150 ^{\circ} C$		700		V			
BV _{DSS}	Breakdown Voltage Temperature	I _D =250μA, V _{GS} =0V		0.65		V/°C			
/∆TJ	Coefficient			0.00		V/ C			
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =600V, V _{GS} =0V			1	μА			
		V _{DS} =480V, T _J =125°C			10				
I _{GSS}	Gate-Body leakage current	$V_{DS}=0V$, $V_{GS}=\pm30V$			±100	nA			
$V_{GS(th)}$	Gate Threshold Voltage	V _{DS} =5V I _D =250μA	3	4	4.5	V			
R _{DS(ON)}	Static Drain-Source On-Resistance	V_{GS} =10V, I_{D} =5A		0.6	0.75	Ω			
g _{FS}	Forward Transconductance	V_{DS} =40V, I_{D} =5A		15		S			
V_{SD}	Diode Forward Voltage	$I_S=1A, V_{GS}=0V$		0.73	1	V			
Is	Maximum Body-Diode Continuous Current				10	Α			
I _{SM}	Maximum Body-Diode Pulsed Current				36	Α			
DYNAMIC	PARAMETERS								
C _{iss}	Input Capacitance		1100	1320	1600	pF			
C _{oss}	Output Capacitance	V_{GS} =0V, V_{DS} =25V, f=1MHz	105	130	170	pF			
C _{rss}	Reverse Transfer Capacitance		7.5	9.3	14	pF			
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz	3	3.8	6	Ω			
SWITCHII	SWITCHING PARAMETERS								
Q_g	Total Gate Charge			31	40	nC			
Q_{gs}	Gate Source Charge	V_{GS} =10V, V_{DS} =480V, I_{D} =10A		6	10	nC			
Q_{gd}	Gate Drain Charge	7		14.4	22	nC			
t _{D(on)}	Turn-On DelayTime			28	35	ns			
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =300V, I_{D} =10A,		66	80	ns			
$t_{D(off)}$	Turn-Off DelayTime	$R_G=25\Omega$		76	95	ns			
t _f	Turn-Off Fall Time	7		64	80	ns			
t _{rr}	Body Diode Reverse Recovery Time	I _F =10A,dI/dt=100A/μs,V _{DS} =100V		290	350	ns			
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =10A,dI/dt=100A/μs,V _{DS} =100V		3.9	4.7	μС			

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B. The power dissipation P_D is based on T_{J(MAX)}=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150°C, Ratings are based on low frequency and duty cycles to keep initial T_J=25°C.

^{=25°}C.

D. The R _{0,JQ} is the sum of the thermal impedence from junction to case R _{0,JC} and case to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300 µs pulses, duty cycle 0.5% max.

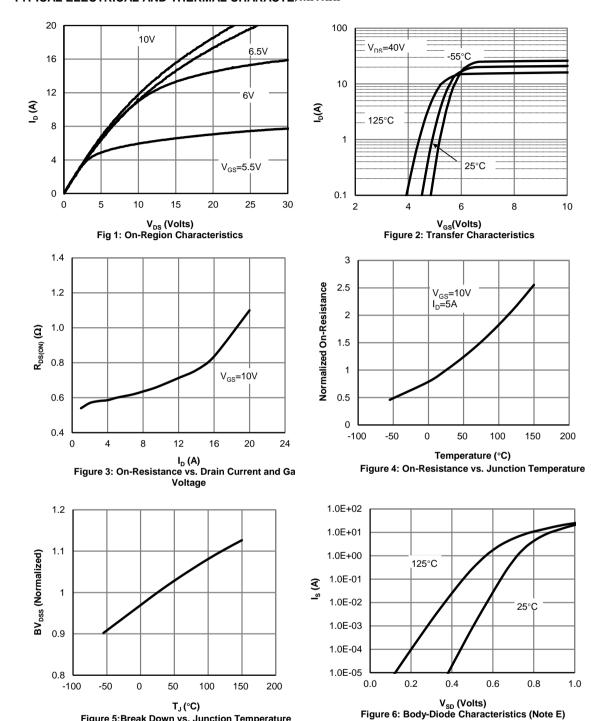
F. These curves are based on the junction-to-case thermal impedence which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of T_{J(MAX)}=150°C. The SOA curve provides a single pulse rating.

G. L=60mH, I_{AS} =4.4A, V_{DD} =150V, R_{G} =25 Ω , Starting T_{J} =25 $^{\circ}$ C



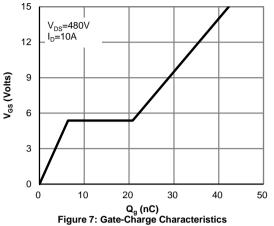
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

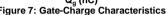
Figure 5:Break Down vs. Junction Temperature

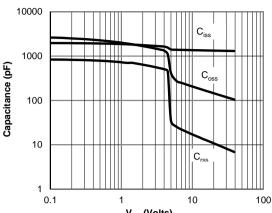




TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS







V_{DS} (Volts)
Figure 8: Capacitance Characteristics

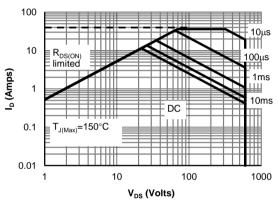


Figure 9: Maximum Forward Biased Safe Operating Area for AOW10N60 (Note F)

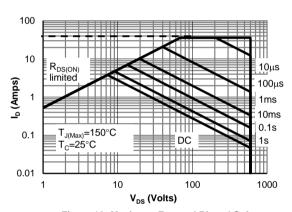
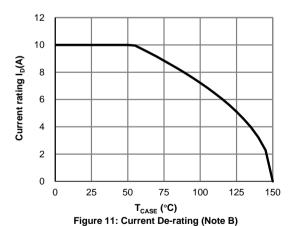


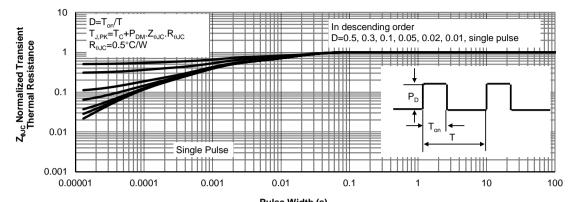
Figure 10: Maximum Forward Biased Safe Operating Area for AOWF10N60 (Note F)



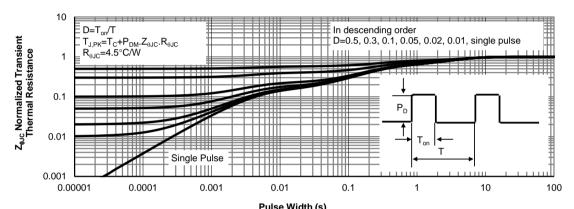
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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



Pulse Width (s)
Figure 12: Normalized Maximum Transient Thermal Impedance for AOW10N60 (Note F)

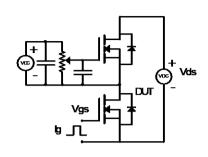


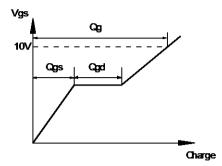
Pulse Width (s)
Figure 13: Normalized Maximum Transient Thermal Impedance for AOWF10N60 (Note F)

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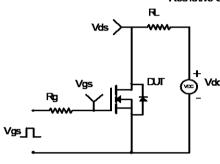


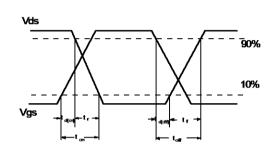
Gate Charge Test Circuit & Waveform



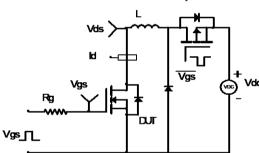


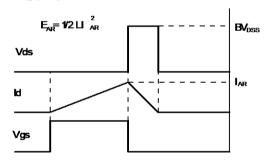
Resistive Switching Test Circuit & Waveforms





Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms

